## 2SC3652

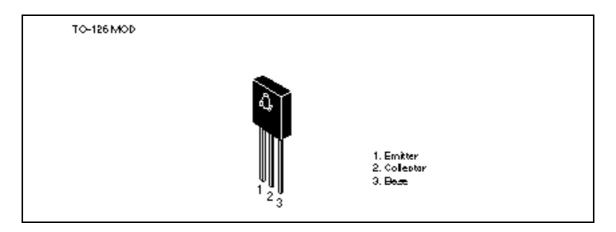
## Silicon NPN Epitaxial

# HITACHI

#### **Application**

High frequency amplifier

#### **Outline**



#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage	V <sub>CEO</sub>	20	V
Emitter to base voltage	$V_{EBO}$	3.5	V
Collector current	I <sub>c</sub>	0.3	Α
Collector peak current	I <sub>C(peak)</sub>	0.5	Α
Collector power dissipation	P <sub>c</sub>	0.8	W
	P <sub>c</sub> *1	5	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at  $T_c = 25$ °C

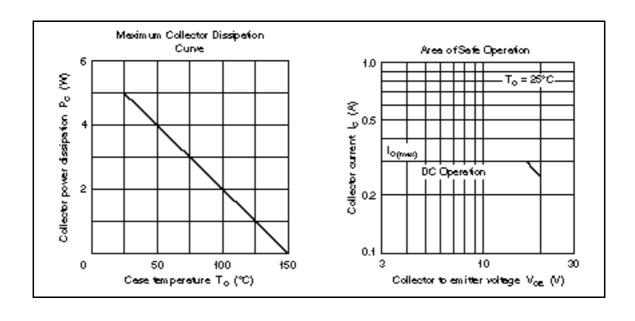


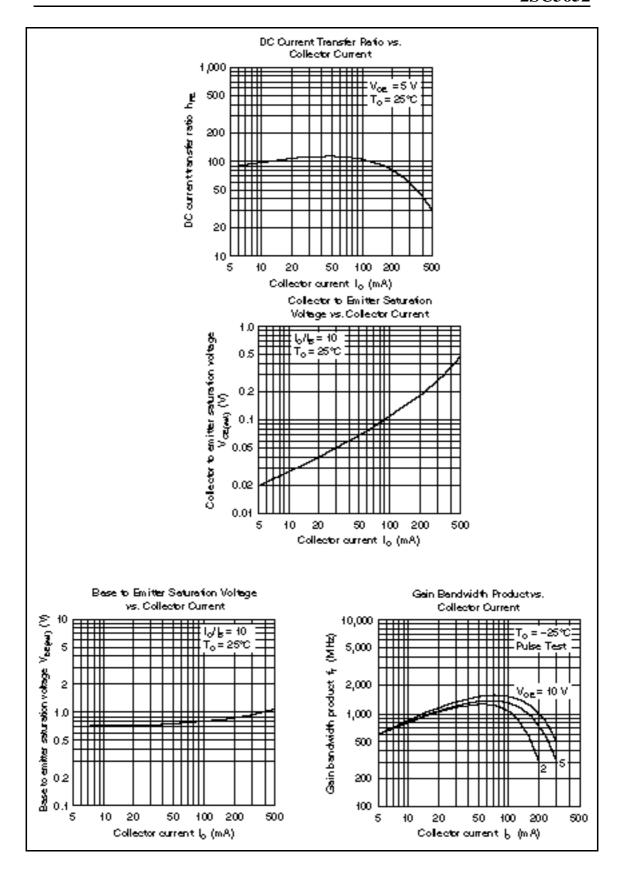
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#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

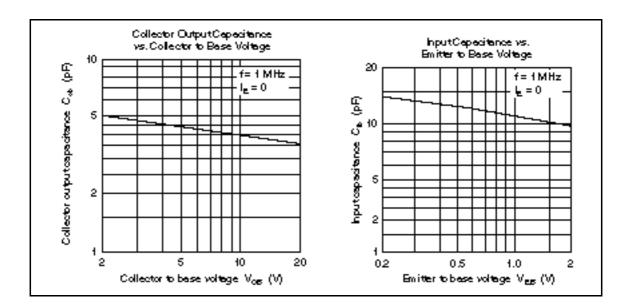
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	20	_	_	V	$I_{\rm C}$ = 10 mA, $R_{\rm BE}$ =
Collector cutoff current	I <sub>CBO</sub>	_	_	1	mA	$V_{CB} = 25 \text{ V}, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	_	_	1	mA	$V_{EB} = 3 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub>	40	_	200		$V_{CE} = 5 \text{ V}, I_{C} = 50 \text{ mA}^{*1}$
Base to emitter voltage	$V_{BE}$	_	_	1.2	V	$V_{CE} = 5 \text{ V}, I_{C} = 300 \text{ mA}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	2.0	V	$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 60 \text{ mA}^{*1}$
Gain bandwidth product	f <sub>T</sub>	_	1.2	_	GHz	$V_{CE} = 5 \text{ V}, I_{C} = 100 \text{ mA}^{*1}$
Collector output capacitance	Cob	_	5	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Input capacitance	Cib	_	10	_	pF	$V_{EB} = 2 \text{ V}, I_{C} = 0, f = 1 \text{ MHz}$

Note: 1. Pulse test





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